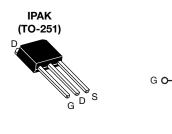
Vishay Siliconix



E Series Power MOSFET

| PRODUCT SUMMARY | | | | | | | |
|--|----------------------------|--|--|--|--|--|--|
| V _{DS} (V) at T _J max. | 650 | | | | | | |
| R _{DS(on)} max. at 25 °C (Ω) | V _{GS} = 10 V 0.6 | | | | | | |
| Q _g max. (nC) | 40 | | | | | | |
| Q _{gs} (nC) | 5 | | | | | | |
| Q _{gd} (nC) | 9 | | | | | | |
| Configuration | Single | | | | | | |



FEATURES

- Low figure-of-merit (FOM) $\rm R_{on} \ x \ Q_{g}$
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
- Welding
 - Induction heating
 - Motor drives
 - Battery chargers
- Renewable energy
- Solar (PV inverters)

| ORDERING INFORMATION | |
|---------------------------------|---------------|
| Package | IPAK (TO-251) |
| Lead (Pb)-free and Halogen-free | SiHU7N60E-GE3 |

S

N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted) | | | | | | | | |
|--|--|-----------------|-------|------|--|--|--|--|
| PARAMETER | SYMBOL | LIMIT | UNIT | | | | | |
| Drain Source Voltage | | V | 600 | | | | | |
| Drain-Source Voltage | $T_{C} = -25 \text{ °C}, I_{D} = 250 \mu\text{A}$ | V _{DS} | 575 | V | | | | |
| Gate-Source Voltage | | V _{GS} | ± 30 | | | | | |
| Continuous Drain Current (T 150 °C) | V_{GS} at 10 V $T_C = 25 \degree C$ $T_C = 100 \degree C$ | | 7 | | | | | |
| Continuous Drain Current (T _J = 150 °C) | $T_{\rm C} = 100 ^{\circ}{\rm C}$ | ID | 5 | А | | | | |
| Pulsed Drain Current ^a | | I _{DM} | 18 | | | | | |
| Linear Derating Factor | | | 0.63 | W/°C | | | | |
| Single Pulse Avalanche Energy ^b | | E _{AS} | 43 | mJ | | | | |
| Maximum Power Dissipation | | PD | 78 | W | | | | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | -55 to +150 | °C | | | | | |
| Drain-Source Voltage Slope | dV/dt | 70 | V/ns | | | | | |
| Reverse Diode dV/dt ^d | uv/ut | 3 | v/115 | | | | | |
| Soldering Recommendations (Peak Temperature) ^c | | 300 | °C | | | | | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 13.8 mH, R_g = 25 Ω , I_{AS} = 2.5 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

S15-0291-Rev. C, 23-Feb-15

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Document Number: 91511



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| THERMAL RESISTANCE RATI | NGS | | | | | | | |
|--|-----------------------|--|---|-----------------------|------|----------|-------|----------|
| PARAMETER | SYMBOL | TYP. | | MAX. | | UNIT | | |
| Maximum Junction-to-Ambient | R _{thJA} | - | | 62 | | | | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | | 1.6 | | | | |
| | | | | | | | | |
| SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u | inless otherwi | ise noted) | | | | | | |
| PARAMETER | SYMBOL | TES | T CONDITIONS | ; | MIN. | TYP. | MAX. | UNIT |
| Static | | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} : | = 0 V, I _D = 250 µ | A | 609 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Referenc | e to 25 °C, I _D = [•] | 1 mA | - | 0.68 | - | V/°C |
| Gate-Source Threshold Voltage (N) | V _{GS(th)} | V _{DS} = | = V _{GS} , I _D = 250 µ | A | 2 | - | 4 | V |
| | | | $V_{GS} = \pm 20 V$ | | - | - | ± 100 | nA |
| Gate-Source Leakage | I _{GSS} | | $V_{GS} = \pm 30 \text{ V}$ | | - | - | ± 1 | μA |
| | | V _{DS} = | = 600 V, V _{GS} = 0 | V | - | - | 1 | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 480 \ | /, V _{GS} = 0 V, T _J : | = 125 °C | - | - | 10 | μA |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 3. | 5 A | - | 0.5 | 0.6 | Ω |
| Forward Transconductance | g fs | V _{DS} | - | 1.9 | - | S | | |
| Dynamic | | | | | | | | |
| Input Capacitance | C _{iss} | | V _{GS} = 0 V, | | - | 680 | - | |
| Output Capacitance | Coss | | $V_{DS} = 100 V,$ | | | 39 | - | pF |
| Reverse Transfer Capacitance | C _{rss} | f = 1 MHz | | | - | 5 | - | |
| Effective Output Capacitance, Energy Related ^a | C _{o(er)} | $V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V | | | - | 34 | - | |
| Effective Output Capacitance, Time Related ^b | C _{o(tr)} | | | | - | 100 | - | |
| Total Gate Charge | Qg | | | | - | 20 | 40 | nC |
| Gate-Source Charge | Q _{gs} | $V_{GS} = 10 V$ | $I_{D} = 3.5 \text{ A}, \text{ V}_{D}$ | _{DS} = 480 V | - | 5 | - | |
| Gate-Drain Charge | Q_gd | | | | - | 9 | - | |
| Turn-On Delay Time | t _{d(on)} | | | | - | 13 | 26 | - ns |
| Rise Time | t _r | V _{DD} = | = 480 V, I _D = 3.5 | А, | - | 13 | 26 | |
| Turn-Off Delay Time | t _{d(off)} | V _{GS} = | = 10 V, R _g = 9.1 | Ω | - | 24 14 | 48 | |
| Fall Time | t _f | | | | | | 28 | <u> </u> |
| Gate Input Resistance | Rg | t = 1 | MHz, open drai | n | - | 1.1 | - | Ω |
| Drain-Source Body Diode Characteristic | cs | | | | 1 | r | T | 1 |
| Continuous Source-Drain Diode Current | ۱ _S | MOSFET symbol showing the | | - | - | 7 | A | |
| Pulsed Diode Forward Current | I _{SM} | integral reverse p - n junction diode | | | - | - | 18 | |
| Diode Forward Voltage | V _{SD} | T _J = 25 °C | C, I _S = 3.5 A, V _G | _S = 0 V | - | - | 1.2 | V |
| Reverse Recovery Time | t _{rr} | | | | - | 230 | - | ns |
| Reverse Recovery Charge | Q _{rr} | $T_J = 2$ | 5 °C, I _F = I _S = 3.5 | 5 A, | - | 1.9 | - | μC |
| Reverse Recovery Current | I _{RRM} | ai/at = | 100 A/µs, V _R = 2 | 20 V | _ | 14 | _ | A |

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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Vishay Siliconix

 $V_{GS} = 10 V$

140 160

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

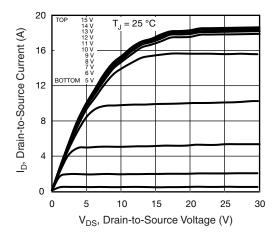


Fig. 1 - Typical Output Characteristics

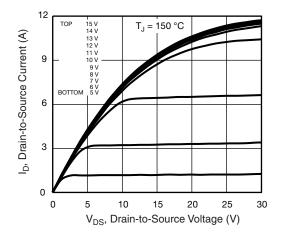


Fig. 2 - Typical Output Characteristics

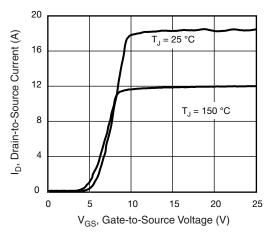
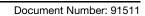


Fig. 3 - Typical Transfer Characteristics

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0 20 20 40 - 60 - 40 -0 60 80 100 120 T_J, Junction Temperature (°C) Fig. 4 - Normalized On-Resistance vs. Temperature 10 000

3

2.5

2

1.5

1

0.5

R_{DS(on)}, Drain-to-Source On Resistance (Normalized)

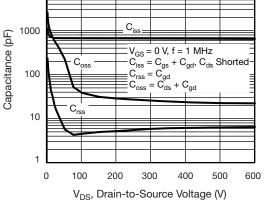


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

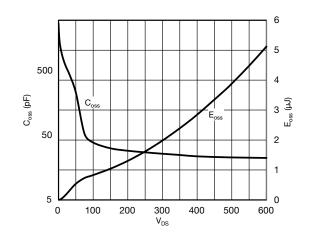


Fig. 6 - Coss and Eoss vs. VDS



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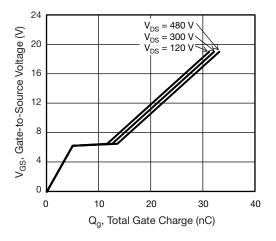


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

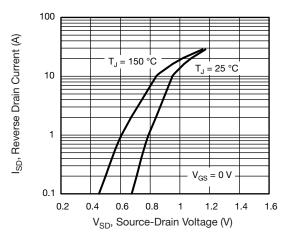


Fig. 8 - Typical Source-Drain Diode Forward Voltage

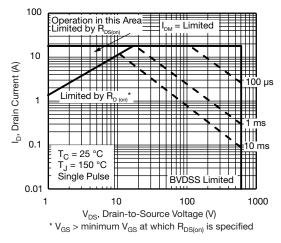


Fig. 9 - Maximum Safe Operating Area

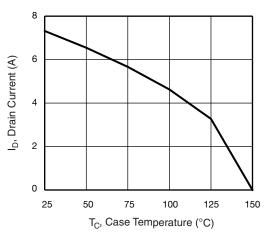


Fig. 10 - Maximum Drain Current vs. Case Temperature

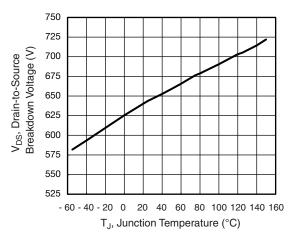


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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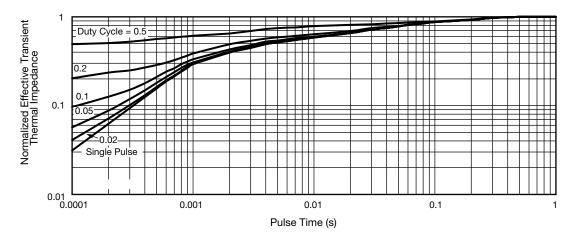


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

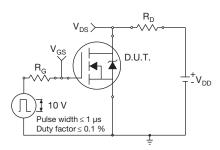


Fig. 13 - Switching Time Test Circuit

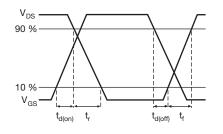


Fig. 14 - Switching Time Waveforms

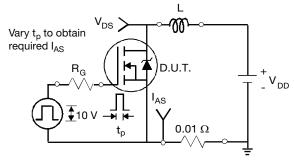


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

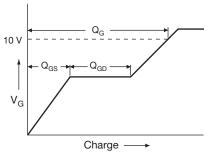
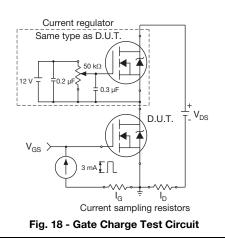


Fig. 17 - Basic Gate Charge Waveform

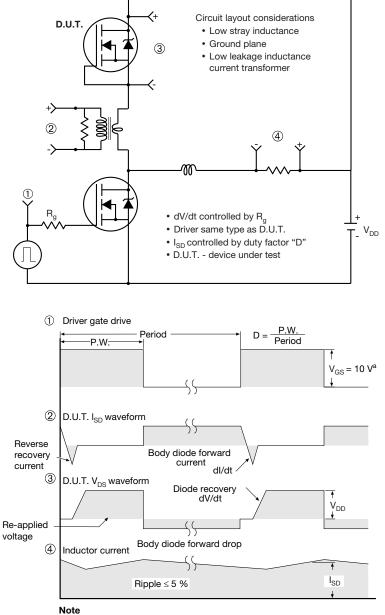


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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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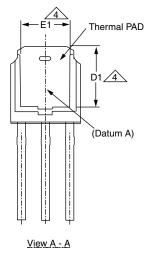
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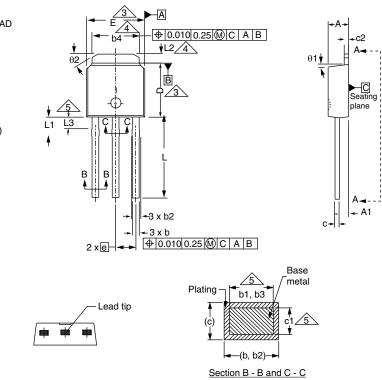


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Case Outline for TO-251AA (High Voltage)

OPTION 1:





| | MILLIN | MILLIMETERS | | INCHES | | | MILLIN | IETERS | INC | HES |
|------|--------|-------------|-------|--------|--|------|----------|--------|-------|-------|
| DIM. | MIN. | MAX. | MIN. | MAX. | | DIM. | MIN. | MAX. | MIN. | MAX |
| А | 2.18 | 2.39 | 0.086 | 0.094 | | D1 | 5.21 | - | 0.205 | - |
| A1 | 0.89 | 1.14 | 0.035 | 0.045 | | Е | 6.35 | 6.73 | 0.250 | 0.265 |
| b | 0.64 | 0.89 | 0.025 | 0.035 | | E1 | 4.32 | - | 0.170 | - |
| b1 | 0.65 | 0.79 | 0.026 | 0.031 | | е | 2.29 BSC | | 2.29 | BSC |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 | | L | 8.89 | 9.65 | 0.350 | 0.380 |
| b3 | 0.76 | 1.04 | 0.030 | 0.041 | | L1 | 1.91 | 2.29 | 0.075 | 0.090 |
| b4 | 4.95 | 5.46 | 0.195 | 0.215 | | L2 | 0.89 | 1.27 | 0.035 | 0.050 |
| С | 0.46 | 0.61 | 0.018 | 0.024 | | L3 | 1.14 | 1.52 | 0.045 | 0.060 |
| c1 | 0.41 | 0.56 | 0.016 | 0.022 | | θ1 | 0' | 15' | 0' | 15' |
| c2 | 0.46 | 0.86 | 0.018 | 0.034 | | θ2 | 25' | 35' | 25' | 35' |
| D | 5.97 | 6.22 | 0.235 | 0.245 | | | • | • | • | • |

DWG: 5968

Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- Dimension are shown in inches and millimeters
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- Thermal pad contour optional with dimensions b4, L2, E1 and D1
- Lead dimension uncontrolled in L3
- Dimension b1, b3 and c1 apply to base metal only
- Outline conforms to JEDEC® outline TO-251AA

Revision: 27-Dec-2021

1

Document Number: 91362

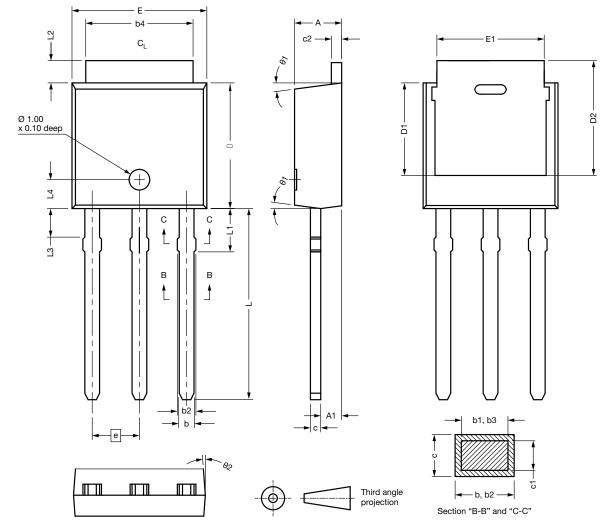
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OPTION 2: FACILITY CODE = N

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| DIM. | MIN. | NOM. | MAX. | 7 [| DIM. | MIN. | NOM. | MAX |
|--------------------------|------------------|--------|-------|-----|------|-------|-------|-------|
| А | 2.180 | 2.285 | 2.390 | | D2 | 5.380 | - | - |
| A1 | 0.890 | 1.015 | 1.140 | | Е | 6.350 | 6.540 | 6.730 |
| b | 0.640 | 0.765 | 0.890 | | E1 | 4.32 | - | - |
| b1 | 0.640 | 0.715 | 0.790 | | е | 2.29 | BSC | |
| b2 | 0.760 | 0.950 | 1.140 | | L | 8.890 | 9.270 | 9.650 |
| b3 | 0.760 | 0.900 | 1.040 | | L1 | 1.910 | 2.100 | 2.290 |
| b4 | 4.950 | 5.205 | 5.460 | | L2 | 0.890 | 1.080 | 1.270 |
| С | 0.460 | - | 0.610 | | L3 | 1.140 | 1.330 | 1.520 |
| c1 | 0.410 | - | 0.560 | | L4 | 1.300 | 1.400 | 1.500 |
| c2 | 0.460 | - | 0.610 | | θ1 | 0° | 7.5° | 15° |
| D | 5.970 | 6.095 | 6.220 | | θ2 | 4° | - | - |
| D1 | 4.300 | - | - | | | | | |
| ECN: E21-06 DWG: 5968 | 82-Rev. C, 27-De | c-2021 | | | | | | |

Notes

• Dimensioning and tolerancing per ASME Y14.5M-1994

• All dimension are in millimeters, angles are in degrees

• Heat sink side flash is max. 0.8 mm

Revision: 27-Dec-2021

Document Number: 91362



Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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